imall

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Transistors with Built-in Resistor DRC3123E0L

DRC3123E0L Silicon NPN epitaxial planar type

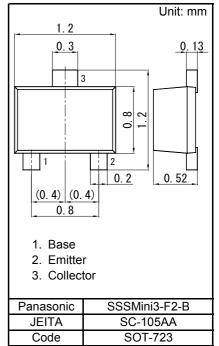
For digital circuits Complementary to DRA3123E DRC9123E in SSSMini3 type package

Features

- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: N2

Packaging

Embossed type (Thermo-compression sealing) : 10 000 pcs / reel (standard)



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/	Internal	Con	nectior	٦
A N C		ᡪᡰᢩᠺ	oC	
	R ₂		o E	
	Resistance	R1	2.2	kΩ
	value	R2	2.2	kΩ

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	50	V
Collector-emitter voltage (Base open)	VCEO	50	V
Collector current	IC	100	mA
Total power dissipation	PT	100	mW
Junction temperature	Tj	150	С°
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

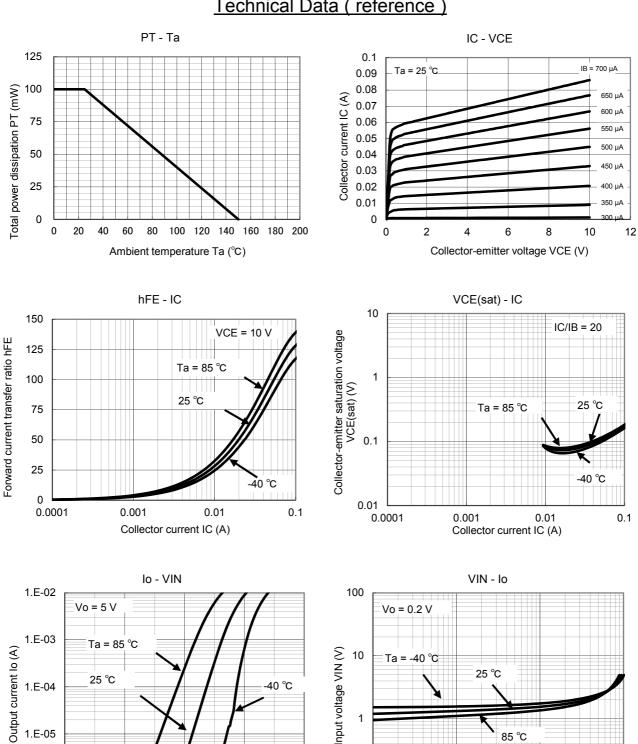
■ Electrical Characteristics Ta = 25 °C ± 3 °C

Symbol	Conditions	N 4 '			
	Conditions	Min	Тур	Max	Unit
VCBO	IC = 10 μA, IE = 0	50			V
VCEO	IC = 2 mA, IB = 0	50			V
ICBO	VCB = 50 V, IE = 0			0.1	μA
ICEO	VCE = 50 V, IB = 0			0.5	μA
IEBO	VEB = 6 V, IC = 0			2.0	mA
hFE	VCE = 10 V, IC = 5 mA	6		20	-
VCE(sat)	IC = 10 mA, IB = 0.5 mA			0.3	V
Vi(on)	VCE = 0.2 V, IC = 5 mA	1.8			V
Vi(off)	VCE = 5 V, IC = 100 μA			0.8	V
R1		-30%	2.2	+30%	kΩ
R1/R2		0.8	1.0	1.2	-
	VCEO ICBO ICEO IEBO hFE VCE(sat) Vi(on) Vi(off) R1	VCEO IC = 2 mA, IB = 0 ICBO VCB = 50 V, IE = 0 ICEO VCE = 50 V, IB = 0 IEBO VEB = 6 V, IC = 0 hFE VCE = 10 V, IC = 5 mA VCE(sat) IC = 10 mA, IB = 0.5 mA Vi(on) VCE = 0.2 V, IC = 5 mA Vi(off) VCE = 5 V, IC = 100 μ A R1 R1	VCEO IC = 2 mA, IB = 0 50 ICBO VCB = 50 V, IE = 0 50 ICEO VCE = 50 V, IB = 0 50 IEBO VEB = 6 V, IC = 0 50 hFE VCE = 10 V, IC = 5 mA 6 VCE(sat) IC = 10 mA, IB = 0.5 mA 1.8 Vi(on) VCE = 5 V, IC = 100 μ A 7.30%	VCEO IC = 2 mA, IB = 0 50 ICBO VCB = 50 V, IE = 0 50 ICEO VCE = 50 V, IB = 0 100 IEBO VEB = 6 V, IC = 0 100 hFE VCE = 10 V, IC = 5 mA 6 VCE(sat) IC = 10 mA, IB = 0.5 mA 1.8 Vi(on) VCE = 5 V, IC = 100 μ A 1.8 Vi(off) VCE = 5 V, IC = 100 μ A -30%	VCEO IC = 2 mA, IB = 0 50 ICBO VCB = 50 V, IE = 0 0.1 ICEO VCE = 50 V, IB = 0 0.5 IEBO VEB = 6 V, IC = 0 2.0 hFE VCE = 10 V, IC = 5 mA 6 20 VCE(sat) IC = 10 mA, IB = 0.5 mA 0.3 0.3 Vi(on) VCE = 5 V, IC = 100 μ A 0.8 0.8 R1 -30% 2.2 +30%

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

Panasonic

Transistors with Built-in Resistor DRC3123E0L



0.1

0.0001

0.001

0.01

Output current lo (A)

2

1.5

Technical Data (reference)

Page 2 of 3

0.1

Established : 2009-10-27 Revised : 2014-03-25

1.E-06

0

0.5

1

Input voltage VIN (V)



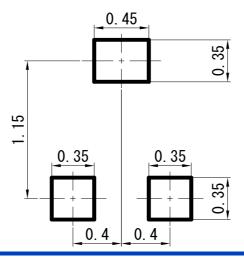
SSSMini3-F2-B

Transistors with Built-in Resistor DRC3123E0L

Unit: mm

1.20 ± 0.05 **0. 13**^{+0. 05} 0. 2 0<u>. 30^{+0.05}</u> 3 0.80 ± 0.05 1.20±0.05 ີ່ເບີ 2 1 **0. 20**^{+0. 05} -0. 02 0.20 ± 0.05 (0.4) (0.4) 0.80 ± 0.05 (5°) 27) 52 ± 0.03 ġ o' 0 to 0.05

Land Pattern (Reference) (Unit: mm)



Page 3 of 3

Established : 2009-10-27 Revised : 2014-03-25

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